LCD Module Product Specification

: APPROVAL FOR SPECIFICATION

For Customer : _____ : APPROVAL FOR SAMPLE

Module No. :TSM12864-6CVersion No.:B

For Customer's Acceptance :

Approved by	Comment

Team Source Display :

Presented by	Reviewed by	Organized by

This module uses ROHS material

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1.FUNCTIONS & FEATURES

- 1-1. Format1-2. LCD Mode1-3. Viewing Angle1-4. Driving Method1-5 Backlight Light
- : 128X64 Dots Graphic
- : STN/BLUE/NEGATIVE/ TRANSMISSIVE
- :6 o'clock
- : 1/64 duty, 1/6 bias,
- : White

2.MECHANICAL SPECIFICATIONS

- 2-1. Module size
- : 78.0(W) *70.0(H)*12.0(T) : 62.0 (W)*44.0(H)
- 2-2. Viewing area : 62.0 (W)*44.0(H) 2-3. Dot pitch : 0.04(W) *0.04(H)
- 2-3. Dot pitch 2-4. Dot size
- 2-4. Dot 3120 2-5.Weight
- : 0.40(W) *0.56(H)
- : about 75g

3.BLOCK DIAGRAM



4.POWER SUPPLY



When Using all Internal LCD Power Circuits (VCI = VDD, 4-time V/C: ON, V/R: ON, V/F: ON)



When Using some Internal LCD Power Circuits (VCI = VDD, V/C: OFF, V/R: ON, V/F: ON)

Team Source Display **5.DIMENSIONAL OUTLINE**

128 X 64 DOTS STN 1/64 DUTY,1/9 BIAS

EXTERNAL DIMENSIONS



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mm

mm

Operating Temperature

Storage Temperature

Ta

Tstg

-20

-30

-70

-80

° C

0.40 x 0.56

0.44 x 0.60

Character Size (WxII)

Character Pitch (WxII)

<u>6. PIN DESCRIPTION</u>

No	SYMBOL	LEVEL	FUNCTION
1	FGND		铁框地线
2	GND	5.0V	Power Supply
3	VDD	0 V	Power Supply
4	V0	0	Supply Voltage For LCD; LCD 驱动电压
5	/WR	L-H	H:Read L:Write 写数据
6	/RD	L-H	Enable Signal 读数据
7	/CE	L	LCD 选通信号,低有效
8	C/D	H/L	命令或数据 高电平/命令 低电平/数据
9	RES	L	复位信号,低有效
10	DB0	H/L	DATA BUS
11	DB1	H/L	DATA BUS
12	DB2	H/L	DATA BUS
13	DB3	H/L	DATA BUS
14	DB4	H/L	DATA BUS
15	DB5	H/L	DATA BUS
16	DB6	H/L	DATA BUS
17	DB7	H/L	DATA BUS
18	FS	H/L	字体选择(H:6X8dots, L:8X8dots)
19	LEDA		LED(+5V)
20	LEDK		LED(0V)
21	VOUT		

7.MAXIMUM ABSOUTE LIMIT (T=25°C)

Item	Sym bol	Standard value	Unit
Power supply voltage for logic	V _{DD}	Vss-0.3~ +5.5.	V
Driver supply voltage	V ₀	0~18	V
Input voltage	V _{IN}	Vss-0.3~V _{DD} +0.3	V
Operating temperature	Topr	-20~+70	°C
Storage temperature	Tstg	-30~+80	°C

Note: Voltage greater than above may damage the module All voltages are specified relative to $V_{SS}=0V$

8.ELECTRICAL CHARACTERISTICS

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ltem	Symbol	Min	Тур	Max	Unit	Test condition			
Operating voltage	VDD	_	5	_	V	_			
LCD driving voltage	V0_VSS	_	10	_	V	_			
Input voltage	VIL	_	_	0.6	V	CMOS LEVEL			
input voltage	V _{IH}	2.6	_	_	V	CMOS LEVEL			
Output voltage	V _{OL}	_	—	0.4	V	0			
	V _{OH}	VDD-0.4	—	-	V	_			
Supply current	I _{DD}	_	35		mA	_			

9 COMMAND LIST

Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description
Display ON / OFF	0	0	1	0	1	0	1	1	1	DON	Turn on/off LCD panel When DON = 0: display OFF When DON = 1: display ON
Initial display line	0	0	0	1	ST5	ST4	ST3	ST2	ST1	ST0	Specify DDRAM line for COM0
Set page address	0	0	1	0	1	1	P3	P2	P1	P0	Set page address
Set column address MSB	0	0	0	0	0	1	Y7	Y6	Y5	Y4	Set column address MSB
Set column address LSB	0	0	0	0	0	0	Y3	Y2	Y1	YO	Set column address LSB
Read status	0	1	BUSY	ADC	ONOFF	RESETB	0	0	0	0	Read the internal status
Write display data	1	0				Write	data				Write data into DDRAM
Read display data	1	1				Read	l data				Read data from DDRAM
ADC select	0	o	1	o	1	0	0	0	O	ADC	Select SEG output direction When ADC = 0: normal direction (SEG0->SEG131) When ADC = 1: reverse direction (SEG131->SEG0)
Reverse display ON / OFF	0	0	1	0	1	0	0	1	1	REV	Select normal / reverse display When REV = 0: normal display When REV = 1: reverse display
Entire display ON / OFF	0	0	1	0	1	0	0	1	0	EON	Select normal/entire display ON When EON = 0: normal display. When EON = 1: entire display ON
LCD bias select	0	0	1	0	1	0	0	0	1	BIAS	Select LCD bias
Set modify-read	0	0	1	1	1	0	0	0	0	0	Set modify-read mode
Reset modify-read	0	0	1	1	1	0	1	1	1	0	release modify-read mode
Reset	0	0	1	1	1	0	0	0	1	0	Initialize the internal functions
SHL select	0	0	1	1	0	0	SHL	×	×	×	Select COM output direction When SHL = 0: normal direction (COM0→COM63) When SHL = 1: reverse direction (COM63→COM0)
Power control	0	0	0	0	1	0	1	VC	VR	VF	Control power circuit operation
Regulator resistor select	0	0	0	0	1	0	0	R2	R1	R0	Select internal resistance ratio o the regulator resistor
Set reference voltage mode	0	0	1	0	0	0	0	0	0	1	Set reference voltage mode
Set reference voltage register	0	0	×	×	SV5	SV4	SV3	SV2	SV1	SV0	Set reference voltage register
Set static indicator mode	0	0	1	0	1	0	1	1	0	SM	Set static indicator mode
Set static indicator register	0	0	×	×	×	×	×	×	S1	S0	Set static indicator register
Power save	-	-	-	-	-	-	-	÷	-	×	Compound Instruction of display OFF and entire display ON
NOP	0	0	1	1	1	0	0	0	1	1	Non-Operation command
Test Instruction_1	0	0	1	1	1	1	×	×	×	×	Don't use this instruction
Test Instruction_2	0	0	1	0	0	1	×	×	×	×	Don't use this instruction



10. TIMING CHARACTERISTICS

Item		C'1			Rat	Units	
item		Signal	Symbol	Condition	Min.	lin. Max.	
Address hold time		AOP	tans		0	<u></u>	ns
Address setup time		AUP	taws		0	-	ns
System cycle time		A0P	teves		300	-	ns
Data setup time Data hold time		DB7 - 0	t _{DS6}	C _L = 100pF	40		ns
			t _{DH8}		15		ns
Access time		DB7 - 0	tacce		122/	140	ns
Output disable time			t _{онв}		10	100	ns
Enchie Hinulae time	Read	50	tewnr		120	-	ns
Enable H pulse time Write		EP	t _{EWHW}		60		ns
Enable L pulse time Read		EP	t _{EWLR}		60	82	ns
		L CP	tewew		60	-	ns



102 LCD Output Timing

Signal	Symbol	Parameter	VDD = 4.	5 to 5.5V	VDD = 2.7	7 to 4.5V	Unit	Condition
Signal Symbol		Falameter	min	max	min	max	Unit	Condition
	tr	Rise time	—	30	_	40	ns	
	tf	Fall time	—	30	—	40	ns	
XSCL	tcx	Shift clock cycle time	4tc	_	4tc		ns	
ASUL	twx	XSCL clock pulsewidth	2tc – 60	—	2tc – 60		ns	
XD0 to	tDH	X data hold time	2tc – 50	—	2tc – 50		ns	CL =
XD3	tDS	X data setup time	2tc – 100	_	2tc – 105	_	ns	100 pF
	tLS	Latch data setup time	2tc – 50	_	2tc – 50	_	ns	
LP	twL	LP pulsewidth	4tc – 80	_	4tc – 120	_	ns	
	tld	LP delay time from XSCL	0	_	0	_	ns	
WF	tDF	Permitted WF delay	_	50	_	50	ns	
YD	TDHY	Y data hold time	2tc - 20	_	2tc - 20	_	ns	

Ta = −20 to 75°C

<u>11.Quality Specifications</u>

11-1. Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

The viewing angle is 30° from viewing direction.

The viewing angle is 10° form reversed viewing direction.



Measuring Method

(e.g. Reflective Type)



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Viewing Angle

θ: Angle between Viewer Direction and Normal.

(-90° $\leqslant \theta \leqslant$ 90°)

 ϕ : Angle between Projection of Viewer Direction to X-Y plane and Y axis.



Measuring Condition

- 1. Driving Voltage: Same as Vop.
- 2. Driving Frequency: Same as Frame Frequency.

11-2. Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	24	
High temp. Operating	70°C	24	No abnormalities
Low temp. Storage	-40°C	24	in functions
Low temp. Operating	-28°C	24	and appearance
Humidity	40°C/ 90%RH	24	
Temp. Cycle	$-28^{\circ}C \leftarrow 25^{\circ}C \rightarrow 70^{\circ}C$	10cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30\min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20 ± 8 °C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

10-3. Precaution for using LCM

LCM is assembled and adjusted with a high degree of precision. Do not attempt to make

any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichl or otrifl or othane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting TS LCD.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C±10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.

- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.

Operation Precautions:

- 1. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 2. For long-term storage over 40°C is required, the relative humidity should be kept below 60%. Avoid direct sunlight.

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